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# LOCTITE<sup>®</sup> SI 5084<sup>™</sup>

Known as LOCTITE<sup>®</sup> 5084<sup>™</sup>  
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## PRODUCT DESCRIPTION

LOCTITE<sup>®</sup> SI 5084<sup>™</sup> provides the following product characteristics:

<b>Technology</b>	Silicone
<b>Chemical Type</b>	Alkoxy silicone
<b>Appearance (uncured)</b>	Translucent straw colored paste <sup>LMS</sup>
<b>Components</b>	One component - requires no mixing
<b>Thixotropic</b>	Reduced migration of liquid product after application to substrate
<b>Cure</b>	Ultraviolet (UV) light
<b>Secondary Cure</b>	Moisture for shadowed areas
<b>Cure Benefit</b>	Production - high speed curing
<b>Application</b>	Gasketing or Sealing
<b>Specific Benefit</b>	Non-corrosive
<b>Flexibility</b>	Enhances load bearing & shock absorbing characteristics of the bond area.
<b>Strength</b>	High

LOCTITE<sup>®</sup> SI 5084<sup>™</sup> resists weathering, moisture, ozone and retains its properties through severe environments.

## TYPICAL PROPERTIES OF UNCURED MATERIAL

Specific Gravity @ 25 °C	1.11
Flash Point - See SDS	
Flow, ISO 7390, mm	0
Extrusion Rate, g/min:	
Pressure 0.63 MPa, time 15 seconds, temperature 25 °C:	
Semco Cartridge	140 to 300 <sup>LMS</sup>

## TYPICAL CURING PERFORMANCE

Normal processing conditions will include exposure to sufficient UV light irradiance to effectively cure the material. Surface and/or atmospheric moisture will promote the cure of material in shadowed regions. Although functional strength is developed almost instantly due to the UV curing nature of LOCTITE<sup>®</sup> SI 5084<sup>™</sup>, increased cure properties are developed during 72 hours at ambient conditions.

## Surface Cure

When curing with sufficient UV light irradiance, exposed material cures dry to the touch in seconds. Atmospheric moisture cures material not exposed to UV light.

Cured for 7 days @ 22 °C / 50±5 % RH:

Skin Over Time, minutes	77
Tack Free Time, minutes	93

Cured @ 250 mW/cm<sup>2</sup> , :

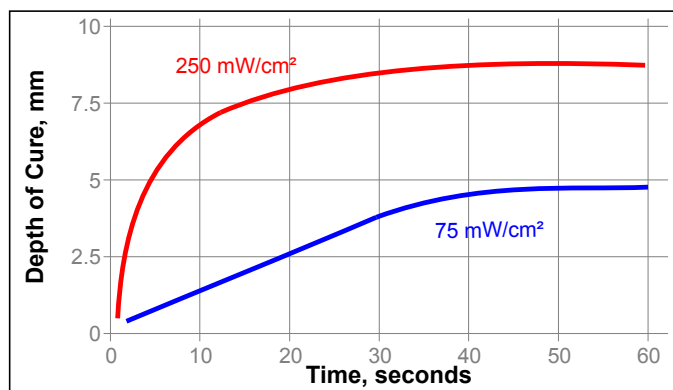
Skin Over Time, seconds	2
Tack Free Time, seconds	4

Cured @ 75 mW/cm<sup>2</sup> , :

Skin Over Time, seconds	2
Tack Free Time, seconds	6

## Depth of Cure

Shadowed areas rely on surface and/or atmospheric moisture to effect cure. Depth of cure is limited to approximately 6 millimeters and will take at least 24 hours to develop. Rapid depth of cure can be attained with focused UV light. The graph(s) below show the depth of cure obtained up to 60 seconds at two different levels of UV irradiance.



## TYPICAL PROPERTIES OF CURED MATERIAL

Cured @ 40 mW/cm<sup>2</sup> , measured @ 365 nm, for 60 seconds per side plus 7 days @ 22 °C / 50% RH

### Physical Properties:

Coefficient of Thermal Expansion, ISO 11359-2, K <sup>-1</sup>	2.93×10 <sup>-4</sup>
Water Absorption, ISO 62, %:	
24 hours in water @ 22 °C	0
Tear Strength, ISO 34-1 , Die B	N/mm 13.2 (lb./in.) (75)
Non-Volatile Content, ASTM D 2369, %	>95



Water Vapor Trans. Rate, ASTM E96, g/(h·m <sup>2</sup> )	0.4
Compression Set, ASTM D 395, Method B, %:	
Aged @ 22 °C for 70 hours	18
Aged @ 75 °C for 70 hours	58
Aged @ 100 °C for 70 hours	84

**Electrical Properties:**

Dielectric Constant / Dissipation Factor, IEC 60250:	
100 Hz	2.99 / 0.002
100 kHz	2.96 / 0.003
Volume Resistivity, IEC 60093, Ω·cm	5.5×10 <sup>14</sup>
Dielectric Breakdown Strength, IEC 60243-1, kV/mm	490

Cured @ 70 mW/cm<sup>2</sup>, measured @ 365 nm, for 60 seconds per side plus 3 days @ 22 °C / 50±5% RH

**Physical Properties:**

Shore Hardness, ISO 868, Durometer A	32 to 47 <sup>LMS</sup>
Elongation, ISO 37, %	≥250 <sup>LMS</sup>
Tensile Strength, ISO 37	N/mm <sup>2</sup> ≥3.4 <sup>LMS</sup> (psi) (≥493)

**TYPICAL PERFORMANCE OF CURED MATERIAL****Adhesive Properties**

Cured @ 40 mW/cm<sup>2</sup>, measured @ 365 nm, for 60 seconds, plus 7 days post UV Cure @ 25 °C / 50% RH

**Lap Shear Strength, ISO 4587:**

Aluminum to Glass	N/mm <sup>2</sup> 1.2 (psi) (175)
Steel to Glass	N/mm <sup>2</sup> 1.5 (psi) (217)
Glass to Glass	N/mm <sup>2</sup> 1.4 (psi) (203)

**180° Peel Strength, ISO 8510-2:**

Aluminum	N/mm 2.1 (lb/in) (12)
Steel	N/mm 2.3 (lb/in) (13)
Glass	N/mm 5.4 (lb/in) (31)

**GENERAL INFORMATION**

**This product is not recommended for use in pure oxygen and/or oxygen rich systems and should not be selected as a sealant for chlorine or other strong oxidizing materials.**

**For safe handling information on this product, consult the Safety Data Sheet (SDS).**

**Directions for use:**

- For best performance bond surfaces should be clean and free from grease.
- The product is designed to be initially cured with UV light at a minimum irradiance of 70 mW/cm<sup>2</sup> for approximately 20 seconds, increased exposure may be required for curing deeper sections.
- Functional strength is achieved almost instantly.
- Full performance properties will develop over 72 hours.
- Moisture curing begins immediately after the product is exposed to the atmosphere, therefore parts to be

assembled should be mated within a few minutes after the product is dispensed.

- Excess material can be easily wiped away with non-polar solvents.

**Loctite Material Specification<sup>LMS</sup>**

LMS dated August 26, 2003. Test reports for each batch are available for the indicated properties. LMS test reports include selected QC test parameters considered appropriate to specifications for customer use. Additionally, comprehensive controls are in place to assure product quality and consistency. Special customer specification requirements may be coordinated through Henkel Quality.

**Storage**

Store product in the unopened container in a dry location. Storage information may be indicated on the product container labeling.

**Optimal Storage: 8 °C to 21 °C. Storage below 8 °C or greater than 28 °C can adversely affect product properties.**

Material removed from containers may be contaminated during use. Do not return product to the original container. Henkel Corporation cannot assume responsibility for product which has been contaminated or stored under conditions other than those previously indicated. If additional information is required, please contact your local Technical Service Center or Customer Service Representative.

**Conversions**

(°C x 1.8) + 32 = °F
kV/mm x 25.4 = V/mil
mm / 25.4 = inches
µm / 25.4 = mil
N x 0.225 = lb
N/mm x 5.71 = lb/in
N/mm <sup>2</sup> x 145 = psi
MPa x 145 = psi
N·m x 8.851 = lb·in
N·m x 0.738 = lb·ft
N·mm x 0.142 = oz·in
mPa·s = cP

**Note:**

The information provided in this Technical Data Sheet (TDS) including the recommendations for use and application of the product are based on our knowledge and experience of the product as at the date of this TDS. The product can have a variety of different applications as well as differing application and working conditions in your environment that are beyond our control. Henkel is, therefore, not liable for the suitability of our product for the production processes and conditions in respect of which you use them, as well as the intended applications and results. We strongly recommend that you carry out your own prior trials to confirm such suitability of our product.

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